

ET5H6ADJY - High Input Ultra-high PSRR 300mA LDO

General Description

ET5H6ADJY is a high input voltage and ultra high PSRR 300mA LDO with enable function that output adjustable from 1.0V~5.0V, which is designed specifically for portable battery-powered applications which require low quiescent current. The consumption of type 50 μ A ensures long battery life and dynamic transient boost feature improves device transient response for wireless communication applications.

ET5H6ADJY offered DFN6 package.

Features

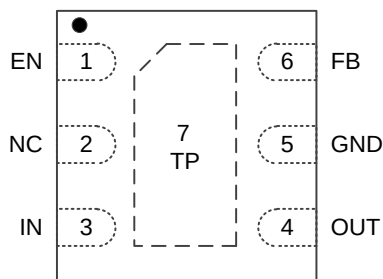
- Wide input voltage range from 2.5V to 24V
- Up to 300mA load current
- low I_Q is 50 μ A typical
- ADJ output voltage range 1.0V~5.0V
- Very low dropout is 270mV at 150mA Load @ $V_{OUT}=3.3V$
- Excellent load/line transient response
- Ultra high ripple rejection is 90dB at 1kHz

Mark Specification Label

Part No.	Package	MSL
ET5H6ADJY	DFN6 (2mm×2mm)	1

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Pin Configuration

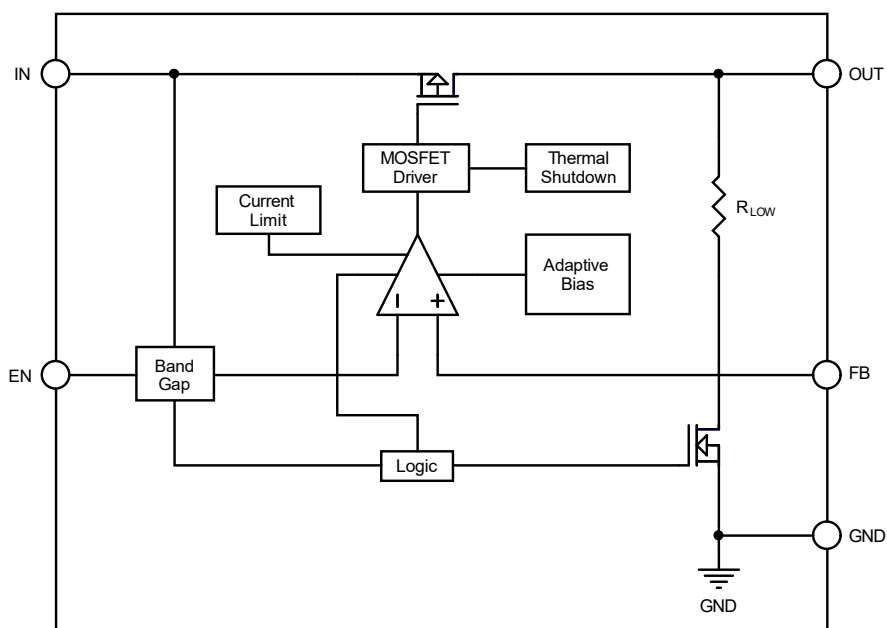


Top View

Pin Function

Pin Name	Pin Function
EN	ON/OFF control , "H" active
NC	No connect
IN	Supply input pin.
OUT	Output pin.
GND	Ground.
FB	Set the output voltage by using divider resistors
TP	Thermal Pad, only be connect to GND or floating, can't be connected to other pins

Block Diagram



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Functional Description

Input Capacitor

A 1 μ F~10 μ F ceramic capacitor is recommended to connect between VIN and GND pins to decouple input power supply glitch and noise. The amount of the capacitance may be increased without limit. This input capacitor must be located as close as possible to the device to assure input stability and less noise. For PCB layout, a wide copper trace is required for both VIN and GND.

Output Capacitor

An output capacitor is required for the stability of the LDO. The recommended output capacitance is from 1 μ F to 10 μ F, Equivalent Series Resistance (ESR) is from 5m Ω to 100m Ω , and temperature characteristics are X7R or X5R. Higher capacitance values help to improve load/line transient response. The output capacitance may be increased to keep low undershoot/overshoot. Place output capacitor as close as possible to OUT and GND pins.

Enable

The ET5H6ADJY delivers the output power when it is set to enable state. When it works in disable state, there is no output power and the operation quiescent current is almost zero. The enable pin (EN) is active high.

Dropout Voltage

The ET5H6ADJY uses a PMOS pass transistor to achieve low dropout. When ($V_{IN} - V_{OUT}$) is less than the dropout voltage (V_{DROP}), the PMOS pass device is in the linear region of operation and the input-to-output resistance is the $R_{DS(ON)}$ of the PMOS pass element. V_{DROP} scales approximately with output current because the PMOS device behaves like a resistor in dropout mode. As with any linear regulator, PSRR and transient response degrade as ($V_{IN} - V_{OUT}$) approaches dropout operation.

Thermal Shutdown

Thermal shutdown protection disables the output when the junction temperature rises to approximately 155°C. Disabling the device eliminates the power dissipated by the device, allowing the device to cool. When the junction temperature cools to approximately 130°C, the output circuitry is again enabled. Depending on power dissipation, thermal resistance, and ambient temperature, the thermal protection circuit may cycle on and off. This cycling limits regulator dissipation, protecting the LDO from damage as a result of overheating. Activating the thermal shutdown feature usually indicates excessive power dissipation as a result of the product of the ($V_{IN} - V_{OUT}$) voltage and the load current. For reliable operation, limit junction temperature to 150°C maximum.

Thermal Considerations

For continuous operation, do not exceed absolute maximum junction temperature. The maximum power dissipation depends on the thermal resistance of the IC package, PCB layout, rate of surrounding airflow, and difference between junction and ambient temperature. The maximum power dissipation can be calculated by the following formula :

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

where $T_{J(MAX)}$ is the maximum junction temperature, T_A is the ambient temperature, and θ_{JA} is the junction to ambient thermal resistance.

For recommended operating condition specifications the maximum junction temperature is 150°C and T_A is

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the ambient temperature. The junction to ambient thermal resistance, θ_{JA} , is layout dependent.

The maximum power dissipation depends on the operating ambient temperature for fixed $T_{J(MAX)}$ and thermal resistance θ_{JA} .

Current-Limit Protection

The ET5H6ADJY provides current limit function to prevent the device from damages during over-load or shorted-circuit condition. This current is detected by an internal sensing transistor.

Layout Guidelines

- Place input and output capacitors as close to the device as possible.
- Use copper planes for device connections in order to optimize thermal performance.
- Place thermal vias around the device to distribute heat.
- Do not place a thermal via directly beneath the thermal pad . A via can wick solder or solder paste away from the thermal pad joint during the soldering process, leading to a compromised solder joint on the thermal pad.
- Thermal pad only be connect to GND or floating, can't be connected to other pins.

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Absolute Maximum Ratings

Symbol	Rating	Value	Unit
$V_{IN}^{(1)}$	Input Voltage	-0.3~30	V
V_{OUT}	Output Voltage	-0.3~6	V
V_{EN}	Chip Enable Input	-0.3~30	V
$T_{J(MAX)}$	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature	-65~150	°C
$V_{ESD}^{(2)}$	HBM Capability	±2000	V
	CDM Capability	±1500	V
$I_{LU}^{(2)}$	Latch up Current Maximum Rating	200	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Note1. Refer to Electrical Characteristics and Application Information for Safe Operating Area.

Note2. This device series incorporates ESD protection and is tested by the following methods:

ESD HBM tested per EIA/JESD22-A114 ;

ESD CDM tested per JESD22-C101;

Latch up Current Maximum Rating tested per JEDEC78.

Thermal Characteristics

Symbol	Package	Ratings	Value	Unit
θ_{JA}	DNF6(2×2)	Thermal Characteristics, Thermal Resistance, Junction-to-Air	125	°C/W

Recommended Operating Conditions

Symbol	Item	Rating	Unit
V_{IN}	Input Voltage	2.5 to 24	V
I_{OUT}	Output Current	0 to 300; 0 to 100 @ $V_{IN}=2.5V$, $V_{OUT}=1.95V$	mA
T_A	Operating Ambient Temperature	-40 to 85	°C
C_{IN}	Effective Input Ceramic Capacitor Value	1 to 10	μF
C_{OUT}	Effective Output Ceramic Capacitor Value	1 to 10	μF
ESR	Input and Output Capacitor Equivalent Series Resistance (ESR)	5 to 100	mΩ

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Electrical Characteristics

($V_{IN} = V_{OUT} + 2V$; $I_{OUT} = 10mA$, $C_{IN} = C_{OUT} = 2.2\mu F$, $T_A = -40^\circ C \sim 85^\circ C$, unless otherwise noted.

Typical values are at $T_A = +25^\circ C$.) ⁽³⁾

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
$V_{IN}^{(4)}$	Operating Input Voltage		2.5		24	V
V_{FB}	FB Voltage	$T_A = +25^\circ C$	0.591	0.600	0.609	V
		$-40^\circ C \leq T_A \leq 85^\circ C$	0.588		0.612	V
$Line_{REG}$	Line Regulation	$V_{OUT} + 2 \leq V_{IN} \leq 24V$ $I_{OUT} = 10mA$		0.05	0.20	% / V
		$2.5V \leq V_{IN} \leq 24V$ $I_{OUT} = 10mA @ V_{OUT} = 1.95V$				
$V_{DROP}^{(5)}$	Dropout Voltage $I_{OUT} = 300mA$	$V_{OUT} = 3.3V$ $T_A = +25^\circ C$		600	950	mV
	Dropout Voltage $I_{OUT} = 150mA$	$V_{OUT} = 3.3V$ $T_A = +25^\circ C$		270	450	mV
	Dropout Voltage $I_{OUT} = 100mA$	$V_{OUT} = 1.95V$ $T_A = +25^\circ C$			550	mV
$Load_{REG}$	Load Regulation	$1mA \leq I_{OUT} \leq 300mA$, $V_{IN} = V_{OUT} + 2V$ $T_A = +25^\circ C$		20	40	mV
		$1mA \leq I_{OUT} \leq 100mA$, $V_{IN} = 2.5V, V_{OUT} = 1.95V$ $T_A = +25^\circ C$				
I_{LMT}	Current Limit	$V_{IN} = V_{OUT} + 2V$, $T_A = +25^\circ C$	350	600	900	mA
I_{SHORT}	Short Current Limit	$V_{IN} = V_{OUT} + 2V$, $T_A = +25^\circ C$	80	150	220	mA
I_{Q_ON}	Quiescent Current	$I_{OUT} = 0mA$, $T_A = +25^\circ C$		50	80	μA
		$I_{OUT} = 0mA$, $T_A = +25^\circ C$ $V_{IN} = 2.5V @ V_{OUT} = 1.95V$		60	90	μA
I_{Q_OFF}	Standby Current	$V_{EN} = 0V$, $T_A = 25^\circ C$ $V_{IN} = 2.5V, V_{IN} = V_{OUT} + 2V$		0.1	1	μA
V_{ENH}	EN Pin Threshold Voltage	EN Input Voltage "H"	1.0			V
V_{ENL}	EN Pin Threshold Voltage	EN Input Voltage "L"			0.4	V
I_{EN}	EN Pin Current	$V_{EN} = 0-24V$		1	2	μA
$PSRR$	Power Supply Rejection Ratio $V_{IN} = V_{OUT} + 2V$ $I_{OUT} = 20mA$	$f = 1 kHz$	70	90		dB
$e_N^{(6)}$	Output Noise Voltage	$V_{IN} = V_{OUT} + 2V$, $I_{OUT} = 1mA$, $f = 10Hz$ to $100KHz$, ($V_{OUT} = 3.3V$) $C_{OUT} = 1\mu F$		70	95	μV_{rms}
R_{DIS}	Output discharge FET R_{dson}	$V_{EN} < V_{IL}$ (output disable)	40	100	160	Ω

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Electrical Characteristics (Continued)

($V_{IN} = V_{OUT} + 2V$; $I_{OUT} = 10mA$, $C_{IN} = C_{OUT} = 2.2\mu F$, $T_A = -40^{\circ}C \sim 85^{\circ}C$, unless otherwise noted.

Typical values are at $T_A = +25^{\circ}C$.) ⁽³⁾

$T_{TSD}^{(6)}$	Thermal Shutdown Temperature	Temperature Increasing from $T_A = +25^{\circ}C$	130	155	180	$^{\circ}C$
$T_{HYS}^{(6)}$	Thermal Shutdown Hysteresis	Temperature Falling from T_{TSD}	15	25	35	$^{\circ}C$

Note3. Here V_{IN} means internal circuit can work normal. If $V_{IN} < V_{OUT}$, Output voltage follow $V_{IN}(I_{OUT}=1mA)$, circuit is safety.

Note4. The minimum operating voltage is 3V. $V_{DROP} = V_{IN(min)} - V_{OUT}$.

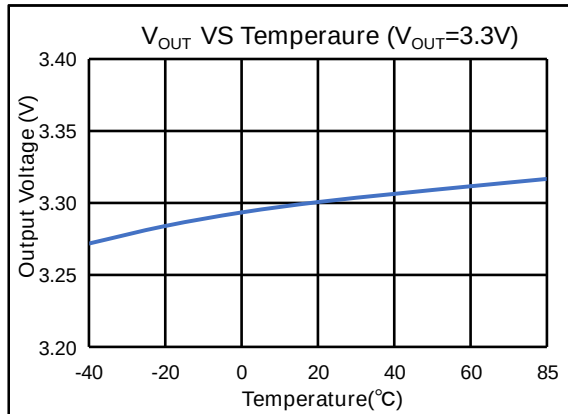
Note5. V_{DROP} FT test method: test the V_{OUT} voltage at $V_{SET} + V_{DROP MAX}$ with 300mA output current.

Note6. Guaranteed by design and characterization. not a FT item.

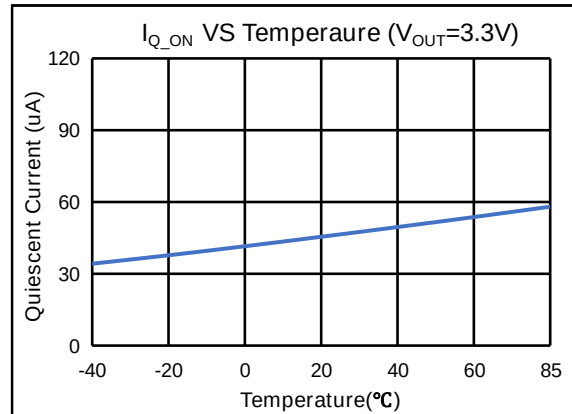
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Typical Characteristics

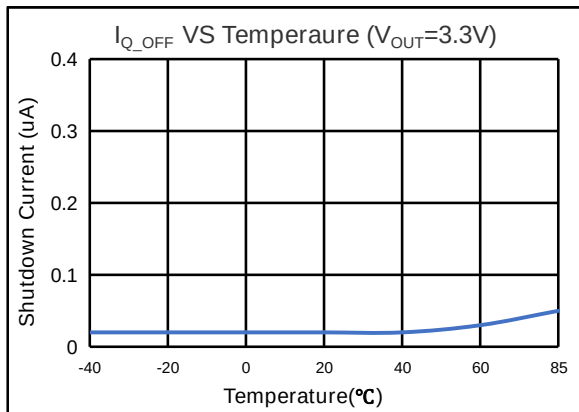
Voltage set 3.3V ($V_{IN}=V_{OUT}+2V$, $I_{OUT}=10mA$, $R1=200k\Omega$, $R2=900k\Omega$, $C_{IN}=C_{OUT}=1.0\mu F$, unless otherwise noted. Typical values are at $T_A=+25^\circ C$).



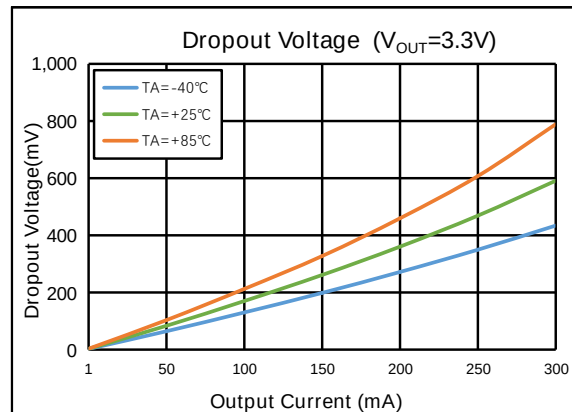
Output Voltage VS Temperature



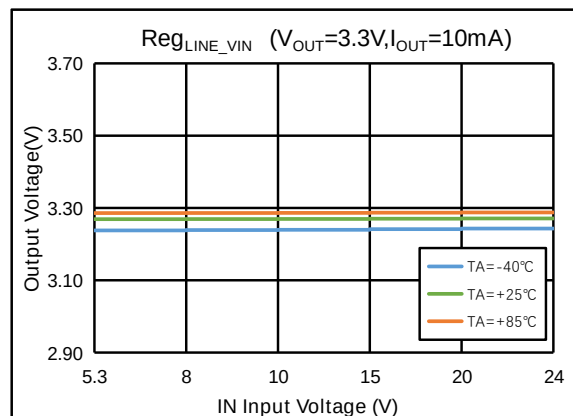
Quiescent Current VS Temperature



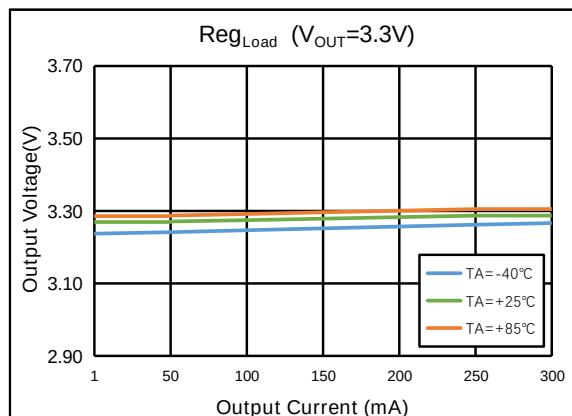
Standby Current VS Temperature



Dropout Voltage VS Output Current



Output Voltage VS Input Voltage

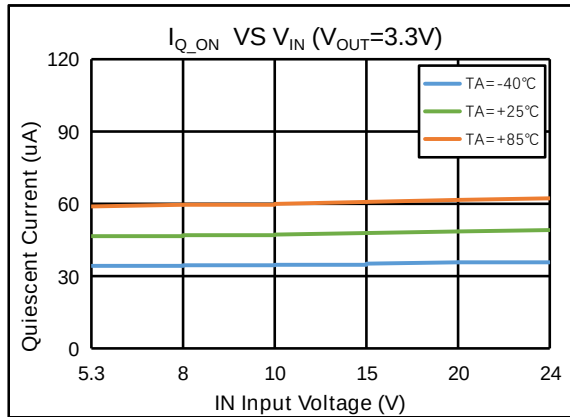


Output Voltage VS Output Current

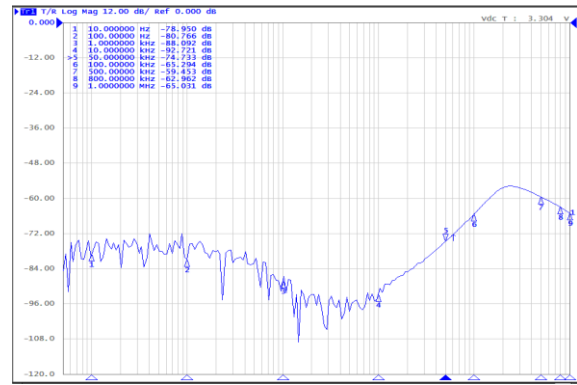
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Typical Characteristics (Continued)

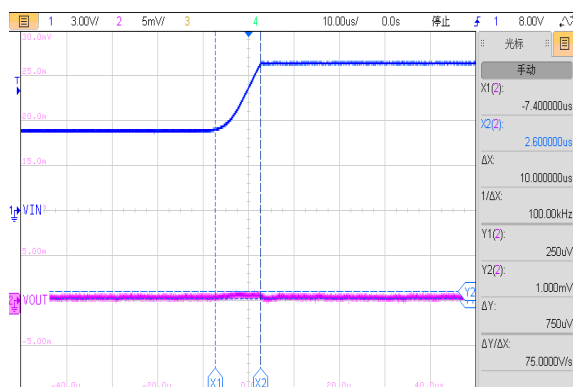
Voltage set 3.3V ($V_{IN}=V_{OUT}+2V$, $I_{OUT}=10mA$, $R1=200k\Omega$, $R2=900k\Omega$, $C_{IN}=C_{OUT}=1.0\mu F$, unless otherwise noted. Typical values are at $T_A=+25^\circ C$.)



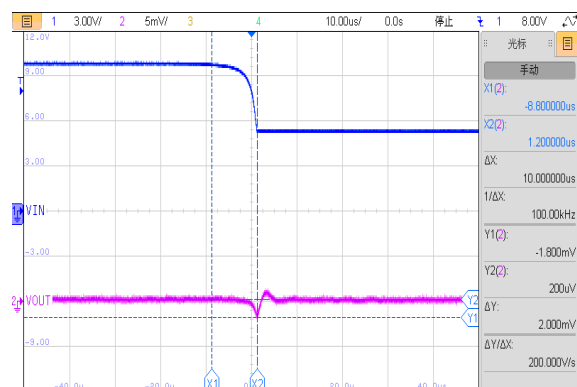
Quiescent Current VS Input Voltage



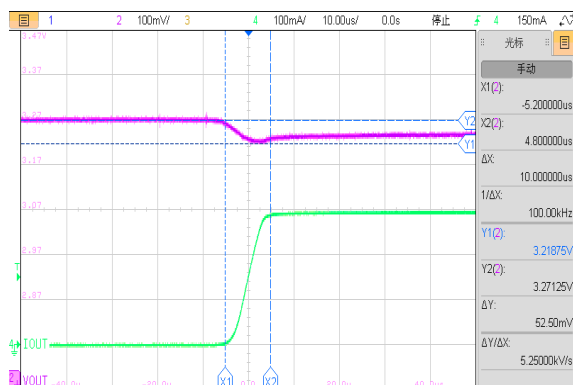
PSRR



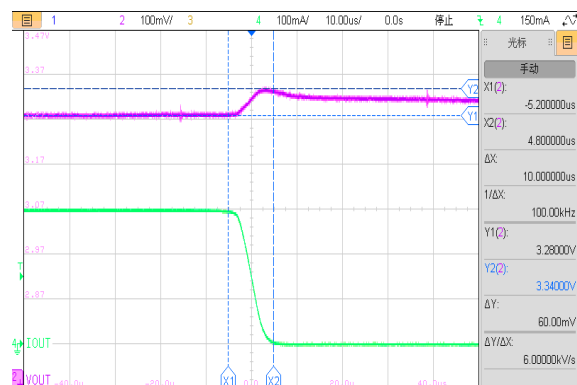
Input-Transient (5.3~10V $t_r=10\mu s$ $I_{OUT}=1mA$)



Input-Transient (10~5.3V $t_f=10\mu s$, $I_{OUT}=1mA$)



Load-Transient ($V_{IN}=5.3V$, $I_{OUT}=1\sim 300mA$ $t_r=10\mu s$)

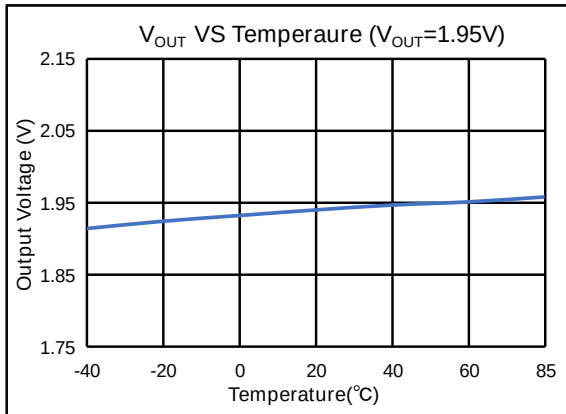


Load-Transient ($V_{IN}=5.3V$, $I_{OUT}=300\sim 1mA$ $t_f=10\mu s$)

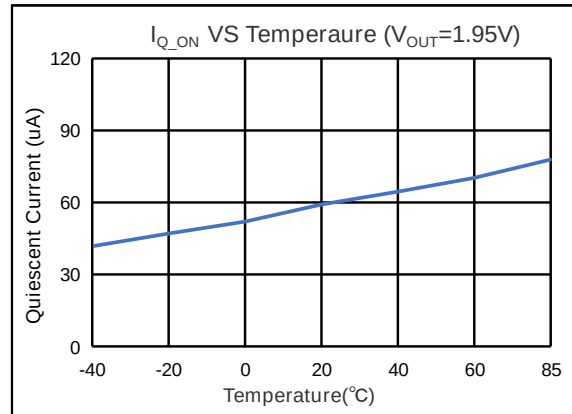
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Typical Characteristics (Continued)

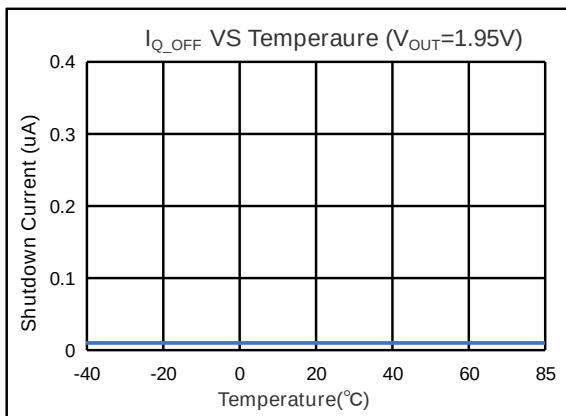
Voltage set 1.95V ($V_{IN}=2.5V$, $I_{OUT}=10mA$, $R1=200k\Omega$, $R2=450k\Omega$, $C_{IN}=C_{OUT}=1.0\mu F$, unless otherwise noted. Typical values are at $T_A=+25^\circ C$.)



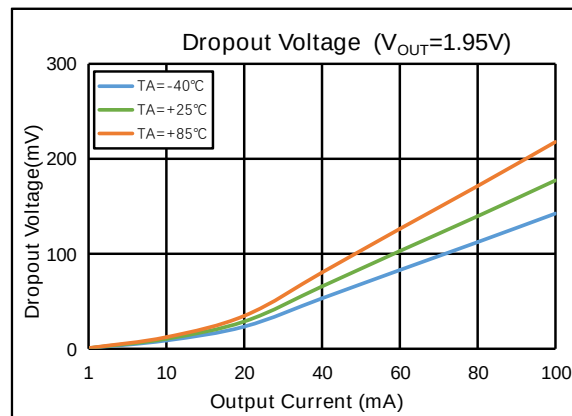
Output Voltage VS Temperature



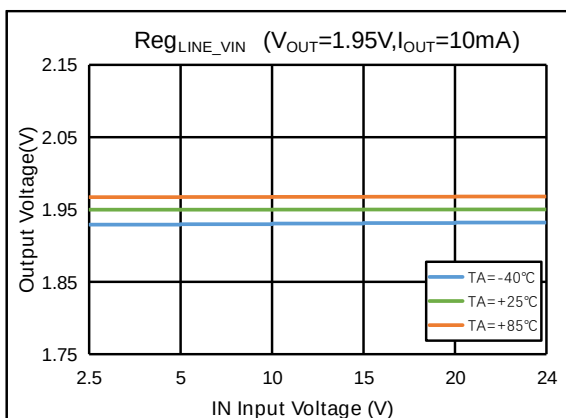
Quiescent Current VS Temperature



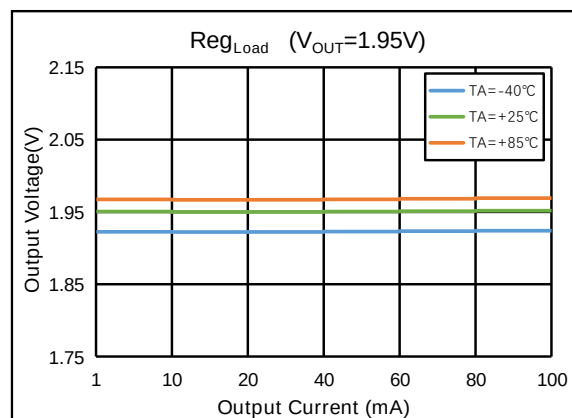
Standby Current VS Temperature



Dropout Voltage VS Output Current



Output Voltage VS Input Voltage

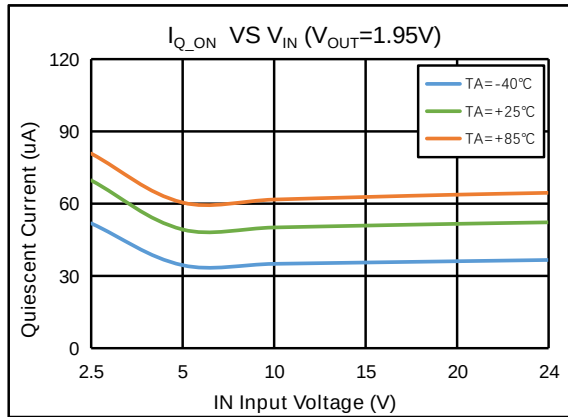


Output Voltage VS Output Current

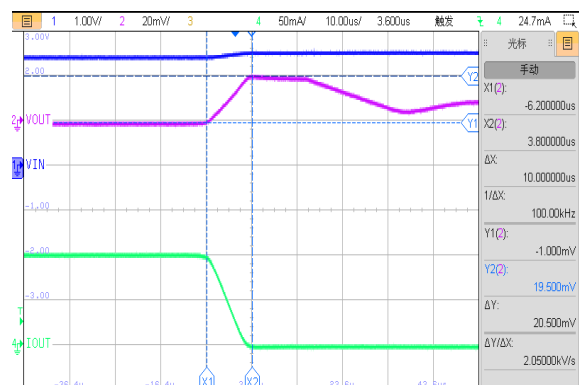
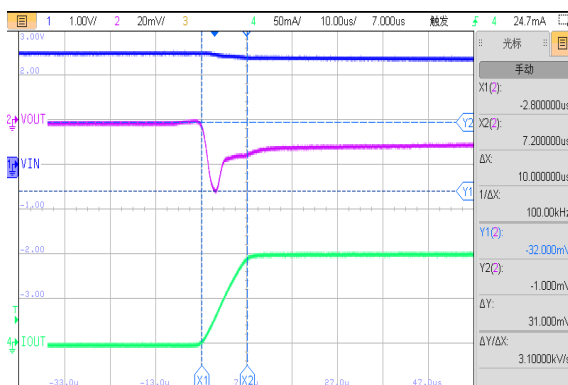
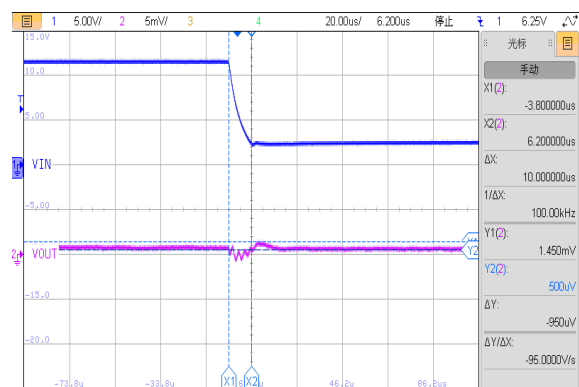
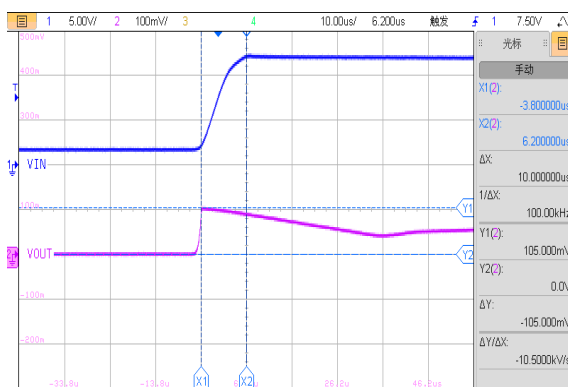
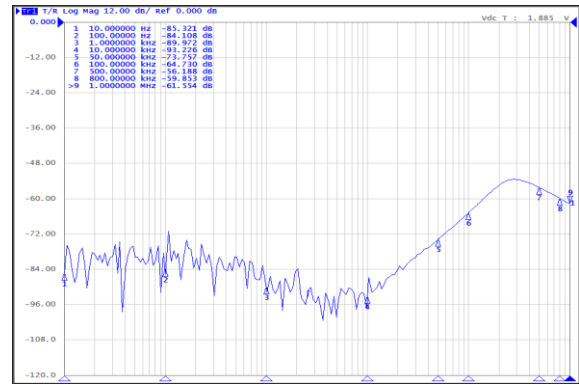
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Typical Characteristics (Continued)

Voltage set 1.95V ($V_{IN}=2.5V$, $I_{OUT}=10mA$, $R1=200k\Omega$, $R2=450k\Omega$, $C_{IN}=C_{OUT}=1.0\mu F$, unless otherwise noted. Typical values are at $T_A=+25^\circ C$.)

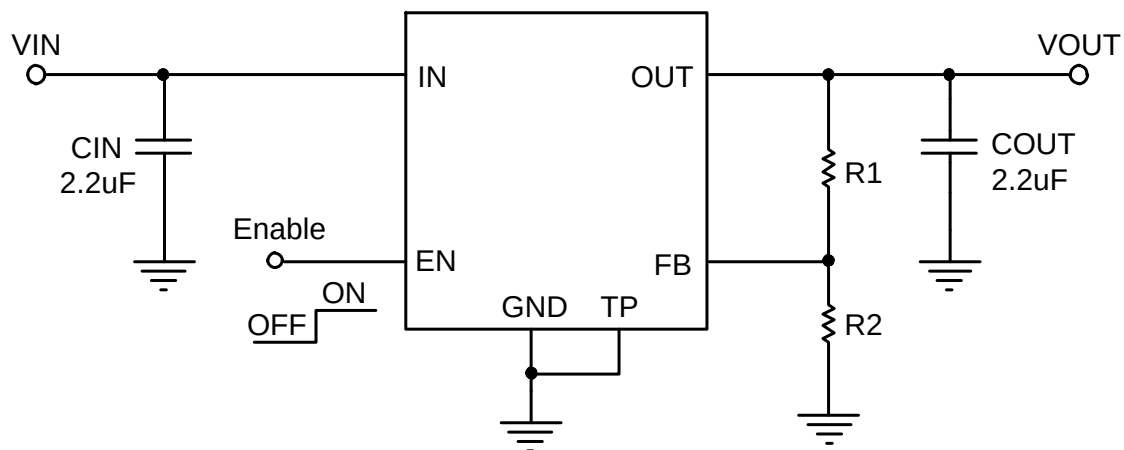


Quiescent Current VS Input Voltage



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Application Circuits

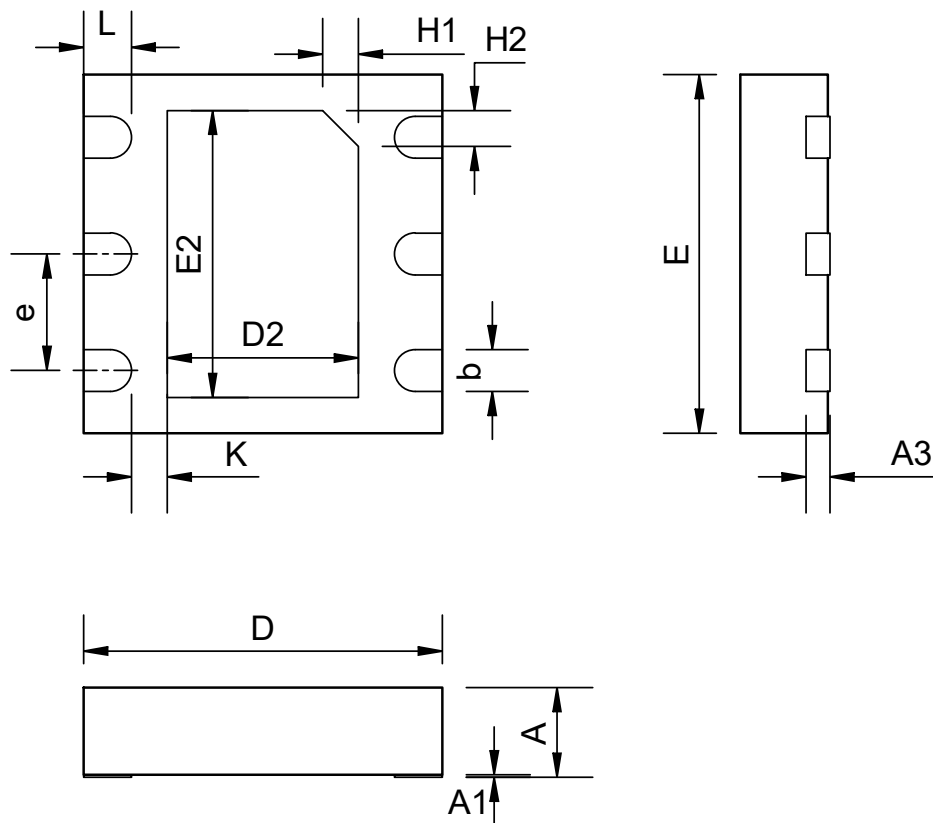


Note *: $V_{OUT}=0.6V \times (R1+R2)/R2$; Recommended $R2=100K \sim 1M$
Thermal pad only be connect to GND or floating, can't be connected to other pins.

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Package Dimension

DFN6



COMMON DIMENSIONS
(UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	NOM	MAX
A	0.70	0.75	0.80
A1	0	--	0.05
A3	0.18	--	0.25
b	0.25	0.30	0.35
D	1.90	2.00	2.10
E	1.90	2.00	2.10
D2	0.90	1.00	1.10
E2	1.50	1.60	1.70
e	0.65BSC		
H1	0.25	0.30	0.35
H2	0.20	0.25	0.30
L	0.20	0.25	0.30
k	0.20	--	--

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Revision History and Checking Table

Version	Date	Revision Item	Modifier	Function & Spec Checking	Package & Tape Checking
0.0	2020-04-28	Preliminary Version	Liuxm	Shibo	Zhuji
0.1	2020-06-01	Preliminary Version	Liuxm	Shibo	Zhuji
0.2	2020-07-17	Preliminary Version	Liuxm	Shibo	Zhuji
1.0	2020-12-17	Initial version	Liuxm	Shibo	Zhuji
1.1	2022-08-08	Update Typeset	Shibo	Shibo	Zhuji
1.2	2024-11-05	Add thermal pad suggest	Shibo	Shibo	Zhuji
1.3	2025-02-17	Add Electrical Characteristics & Typical Characteristics of $V_{OUT}=1.95V$	Pengjj	Pengjj	Zhuji